

PRELIMINARY

**NEC** NEC LCD Technologies, Ltd.

# TFT COLOR LCD MODULE


**NL10276BC30-34D**

**38cm (15.0 Type)**

**XGA**

**LVDS interface (1port)**

## PRELIMINARY DATA SHEET

DOD-PP-0753 (1st edition) 

**All information is subject to change without notice.  
Please confirm the sales representative before  
starting to design your system.**

---

## INTRODUCTION

The Copyright to this document belongs to NEC LCD Technologies, Ltd. (hereinafter called "NEC"). No part of this document will be used, reproduced or copied without prior written consent of NEC.

NEC does and will not assume any liability for infringement of patents, copyrights or other intellectual property rights of any third party arising out of or in connection with application of the products described herein except for that directly attributable to mechanisms and workmanship thereof. No license, express or implied, is granted under any patent, copyright or other intellectual property right of NEC.

Some electronic parts/components would fail or malfunction at a certain rate. In spite of every effort to enhance reliability of products by NEC, the possibility of failures and malfunction might not be avoided entirely. To prevent the risks of damage to death, human bodily injury or other property arising out thereof or in connection therewith, each customer is required to take sufficient measures in its safety designs and plans including, but not limited to, redundant system, fire-containment and anti-failure.

The products are classified into three quality grades: "**Standard**", "**Special**", and "**Specific**" of the highest grade of a quality assurance program at the choice of a customer. Each quality grade is designed for applications described below. Any customer who intends to use a product for application other than that of Standard quality grade is required to contact an NEC sales representative in advance.

The **Standard** quality grade applies to the products developed, designed and manufactured in accordance with the NEC standard quality assurance program, which are designed for such application as any failure or malfunction of the products (sets) or parts/components incorporated therein a customer uses are, directly or indirectly, free of any damage to death, human bodily injury or other property, like general electronic devices.

Examples: Computers, office automation equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment, industrial robots, etc.

The **Special** quality grade applies to the products developed, designed and manufactured in accordance with an NEC quality assurance program stricter than the standard one, which are designed for such application as any failure or malfunction of the products (sets) or parts/components incorporated therein a customer uses might directly cause any damage to death, human bodily injury or other property, or such application under more severe condition than that defined in the Standard quality grade without such direct damage.

Examples: Control systems for transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, medical equipment not specifically designed for life support, safety equipment, etc.

The **Specific** quality grade applies to the products developed, designed and manufactured in accordance with the standards or quality assurance program designated by a customer who requires an extremely higher level of reliability and quality for such products.

Examples: Military systems, aircraft control equipment, aerospace equipment, nuclear reactor control systems, medical equipment/devices/systems for life support, etc.

The quality grade of this product is the "**Standard**" unless otherwise specified in this document.

## CONTENTS

<b>INTRODUCTION</b> .....	2
<b>1. OUTLINE</b> .....	4
1.1 STRUCTURE AND PRINCIPLE .....	4
1.2 APPLICATION .....	4
1.3 FEATURES .....	4
<b>2. GENERAL SPECIFICATIONS</b> .....	5
<b>3. BLOCK DIAGRAM</b> .....	6
<b>4. DETAILED SPECIFICATIONS</b> .....	8
4.1 MECHANICAL SPECIFICATIONS .....	8
4.2 ABSOLUTE MAXIMUM RATINGS .....	8
4.3 ELECTRICAL CHARACTERISTICS .....	9
4.3.1 LCD panel signal processing board .....	9
4.3.2 Backlight lamp .....	10
4.3.3 Power supply voltage ripple .....	11
4.3.4 Fuse .....	11
4.4 POWER SUPPLY VOLTAGE SEQUENCE .....	12
4.4.2 Backlight lighting circuit .....	12
4.5 CONNECTIONS AND FUNCTIONS FOR INTERFACE PINS .....	13
4.5.1 LCD panel signal processing board .....	13
4.5.2 Backlight .....	14
4.5.3 Positions of plug and socket .....	14
4.5.4 Connection between receiver and transmitter for LVDS .....	15
4.6 DISPLAY COLORS AND INPUT DATA SIGNALS .....	17
4.7 DISPLAY POSITIONS .....	18
4.8 SCANNING DIRECTIONS .....	18
4.9 INPUT SIGNAL TIMINGS .....	19
4.9.1 Outline of input signal timings .....	19
4.9.2 Timing characteristics .....	20
4.9.3 Input signal timing chart .....	21
4.10 OPTICS .....	22
4.10.1 Optical characteristics .....	22
4.10.2 Definition of contrast ratio .....	23
4.10.3 Definition of luminance uniformity .....	23
4.10.4 Definition of response times .....	23
4.10.5 Definition of viewing angles .....	23
<b>5. ESTIMATED LUMINANCE LIFETIME</b> .....	24
<b>6. RELIABILITY TESTS</b> .....	25
<b>7. PRECAUTIONS</b> .....	26
7.1 MEANING OF CAUTION SIGNS .....	26
7.2 CAUTIONS .....	26
7.3 ATTENTIONS .....	26
7.3.1 Handling of the product .....	26
7.3.2 Environment .....	27
7.3.3 Characteristics .....	27
7.3.4 Other .....	27
<b>8. OUTLINE DRAWINGS</b> .....	28
8.1 FRONT VIEW .....	28
8.2 REAR VIEW .....	29
<b>REVISION HISTORY</b> .....	30

## 1. OUTLINE

### 1.1 STRUCTURE AND PRINCIPLE

Color LCD module NL10276BC30-34D is composed of the amorphous silicon thin film transistor liquid crystal display (a-Si TFT LCD) panel structure with driver LSIs for driving the TFT (Thin Film Transistor) array and a backlight.

The a-Si TFT LCD panel structure is injected liquid crystal material into a narrow gap between the TFT array glass substrate and a color-filter glass substrate.

Color (Red, Green, Blue) data signals from a host system (e.g. signal generator, etc.) are modulated into best form for active matrix system by a signal processing board, and sent to the driver LSIs which drive the individual TFT arrays.

The TFT array as an electro-optical switch regulates the amount of transmitted light from the backlight assembly, when it is controlled by data signals. Color images are created by regulating the amount of transmitted light through the TFT array of red, green and blue dots.

### 1.2 APPLICATION

- For industrial use

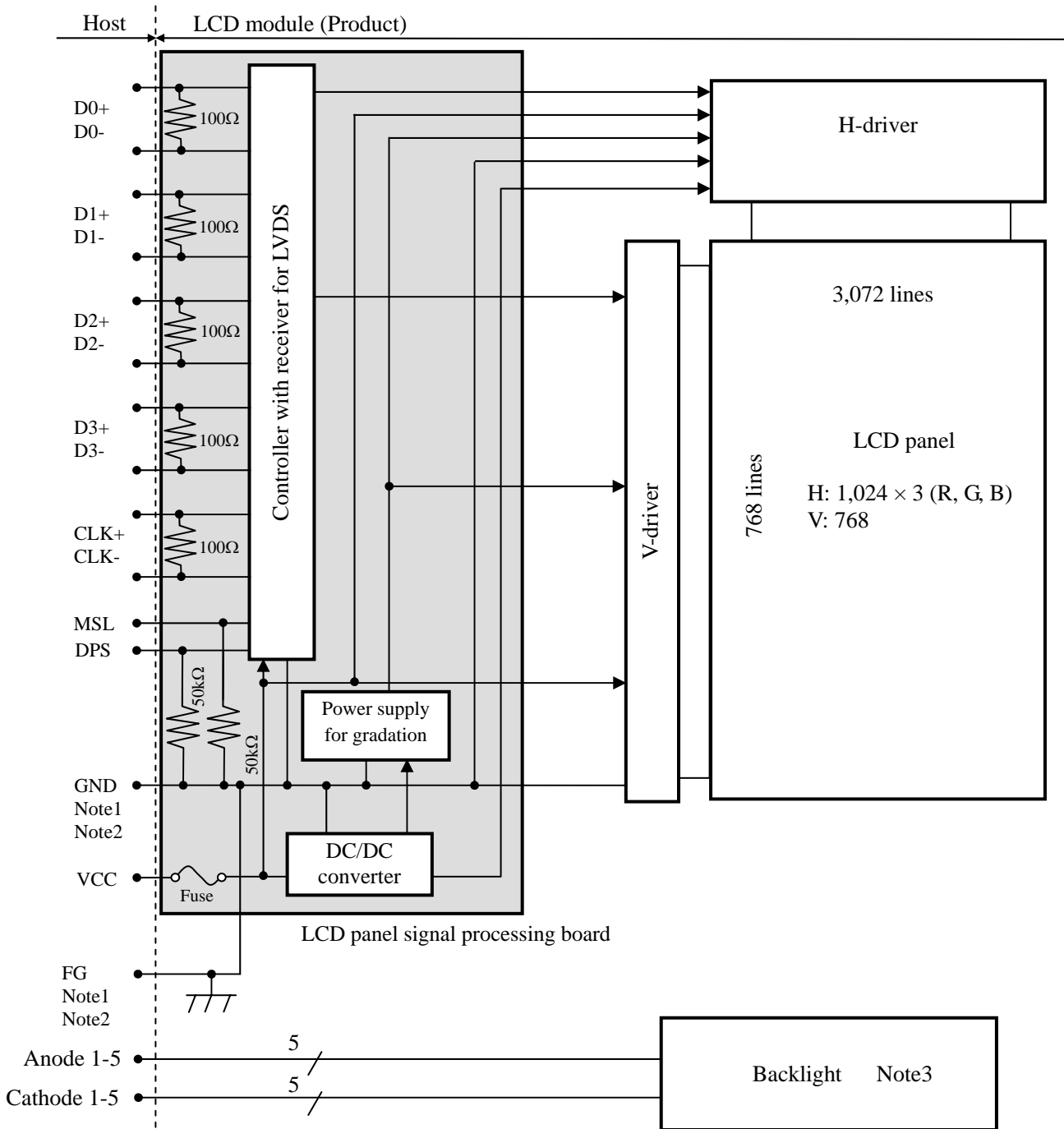
### 1.3 FEATURES

- Wide viewing angle
- Fast response time
- LVDS interface (8-bit)
- Selectable LVDS input map
- Reversible-scan direction
- Small foot print
- Long life LED backlight type
- Replaceable lamp holder for backlight

## 2. GENERAL SPECIFICATIONS

<b>Display area</b>	304.128 (H) × 228.096 (V) mm	
<b>Diagonal size of display</b>	38cm (15.0 inches)	
<b>Drive system</b>	a-Si TFT active matrix	
<b>Display color</b>	16,777,216 colors (6bit+FRC)	
<b>Pixel</b>	1,024 (H) × 768 (V) pixels	
<b>Pixel arrangement</b>	RGB (Red dot, Green dot, Blue dot) vertical stripe	
<b>Dot pitch</b>	0.099 (H) × 0.297 (V) mm	
<b>Pixel pitch</b>	0.297 (H) × 0.297 (V) mm	
<b>Module size</b>	326.5 (typ. W) × 253.5 (typ. H) × (12.0) (max. D) mm	Note 1
<b>Weight</b>	970g (typ.)	
<b>Contrast ratio</b>	500:1 (typ.)	
<b>Viewing angle</b>	At the contrast ratio ≥ 10:1 <ul style="list-style-type: none"> <li>• Horizontal: Right side 80° (typ.), Left side 80° (typ.)</li> <li>• Vertical: Up side 80° (typ.), Down side 80° (typ.)</li> </ul>	
<b>Designed viewing direction</b>	At DPS terminal = Low or Open: Normal scan <ul style="list-style-type: none"> <li>• Viewing direction without image reversal: Up side (12 o'clock)</li> <li>• Viewing direction with contrast peak: Down side (6 o'clock)</li> <li>• Viewing angle with optimum grayscale (<math>\gamma \approx 2.2</math>): Normal axis (perpendicular)</li> </ul>	
<b>Polarizer surface</b>	Antiglare	
<b>Polarizer pencil-hardness</b>	3H (min.) [by JIS K5400]	
<b>Color gamut</b>	At LCD panel center 50% (typ.) [against NTSC color space]	
<b>Response time</b>	Ton + Toff (10% ← → 90%) 18ms (typ.)	
<b>Luminance</b>	At IL = 50mA / One circuit 400cd/m <sup>2</sup> (typ.)	
<b>Signal system</b>	LVDS 1port (Receiver: Equivalent of THC63LVDF84B, THine Electronics Inc.) [8-bit digital signals for data of RGB colors, Dot clock (CLK), Data enable (DE)]	
<b>Power supply voltage</b>	LCD panel signal processing board: 3.3V	
<b>Backlight</b>	LED Backlight type: ( Replaceable part • Lamp holder set: Type No. TBD )	
<b>Power consumption</b>	At IL = 50mA / One circuit, Checkered flag pattern 10.6W (typ.)	

### 3. BLOCK DIAGRAM



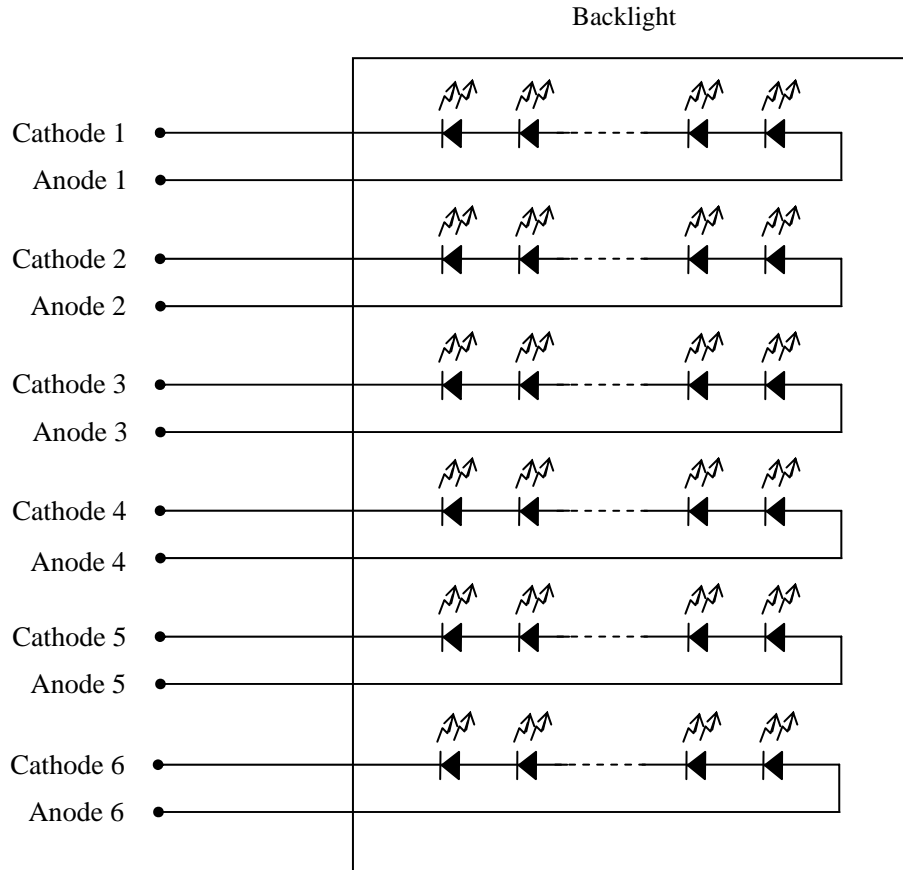
Note1: Relations between GND (Signal ground) and FG (Frame ground) in the LCD module is as follows.

GND-FG	Connected
--------	-----------

Note2: GND and FG must be connected to customer equipment's ground, and it is recommended that GND and FG are connected together in customer equipment.

# PRELIMINARY

Note3: Detail of backlight



## 4. DETAILED SPECIFICATIONS

### 4.1 MECHANICAL SPECIFICATIONS

Parameter	Specification	Unit
Module size	326.5 ± 0.5 (W) × 253.5 ± 0.5 (H) × (12.0) max. (D) Note1,	mm
Display area	304.128 (H) × 228.096 (V) Note1	mm
Weight	970(typ.), 1,050 (max.)	g

Note1: See "8. OUTLINE DRAWINGS".

### 4.2 ABSOLUTE MAXIMUM RATINGS

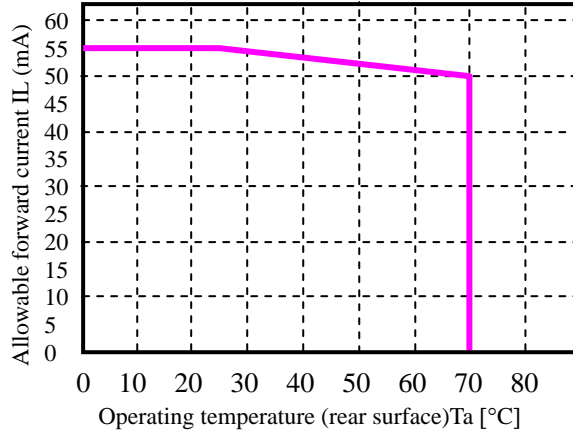
Parameter	Symbol	Rating	Unit	Remarks
Power supply voltage	VCC	-0.3 to +4.0	V	-
Input voltage for signals	VD	-0.3 to VCC+0.3	V	
	VF			
Backlight	PD	(600)	mW	per one circuit
	IL	Note3	mA	
Storage temperature	Tst	-20 to +70	°C	Note4
Operating temperature	Top	-20 to +70	°C	Note5
Relative humidity Note6	RH	≤ 95	%	Ta ≤ 40°C
		≤ 85	%	40 < Ta ≤ 50°C
		≤ 55	%	50 < Ta ≤ 60°C
		≤ 36	%	60 < Ta ≤ 70°C
Absolute humidity Note6	AH	≤ 70 Note7	g/m <sup>3</sup>	Ta > 60°C

Note1: D0+/-, D1+/-, D2+/-, D3+/-, CLK+/-

Note2: MSL, DPS



Note3 Forward current



- Note4: Measured at LCD panel surface (including self-heat)
- Note5: Measured at LCD module's rear shield surface (including self-heat)
- Note6: No condensation
- Note7: Water amount at Ta= 70°C and RH= 36%

### 4.3 ELECTRICAL CHARACTERISTICS

#### 4.3.1 LCD panel signal processing board

(Ta= 25°C)

Parameter	Symbol	min.	typ.	max.	Unit	Remarks	
Power supply voltage	VCC	3.0	3.3	3.6	V	-	
Power supply current	ICC	-	500 Note1	700 Note2	mA	at VCC= 3.3V	
Permissible ripple voltage	VRP	-	-	100	mVp-p	for VCC	
Differential input threshold voltage for LVDS receiver	High	VTH	-	-	+100	mV	at VCM= 1.2V Note3
	Low	VTL	-100	-	-	mV	
Input voltage swing for LVDS receiver	Vi	0	-	2.4	V	-	
Terminating resistance	RT	-	100	-	Ω	-	
Input voltage for MSL and DPS signal	High	VFH	2.0	-	VCC	V	-
	Low	VFL	0	-	0.8	V	
Input current for MSL and DPS signal	High	IFH	-	-	300	μA	-
	Low	IFL	-300	-	-	μA	

- Note1: Checkered flag pattern [by EIAJ ED-2522]
- Note2: Pattern for maximum current
- Note3: Common mode voltage for LVDS receiver

# PRELIMINARY

## 4.3.2 Backlight lamp

(Ta= 25°C, Note1, Note2 Note3)

Parameter	Symbol	min.	typ.	max.	Unit	Remarks
Forward Current	IL	-	50	55	mA	-
Forward Voltage	VL	-	29.7	34.2	V	at IL= 50 mA / One circuit

Note1: Please drive with constant current.

Note2: The Luminance uniformity may be changed depending on the current variation between 6 circuits.

It is recommended that the current value difference between each circuit is less than 5%.

Note3: See “**4.2 ABSOLUTE MAXIMUM RATING**”

# PRELIMINARY

### 4.3.3 Power supply voltage ripple

This product works, even if the ripple voltage levels are beyond the permissible values as following the table, but there might be noise on the display image.

Power supply voltage		Ripple voltage (Measure at input terminal of power supply)	Note1	Unit
VCC	3.3V	≤ 100		mVp-p

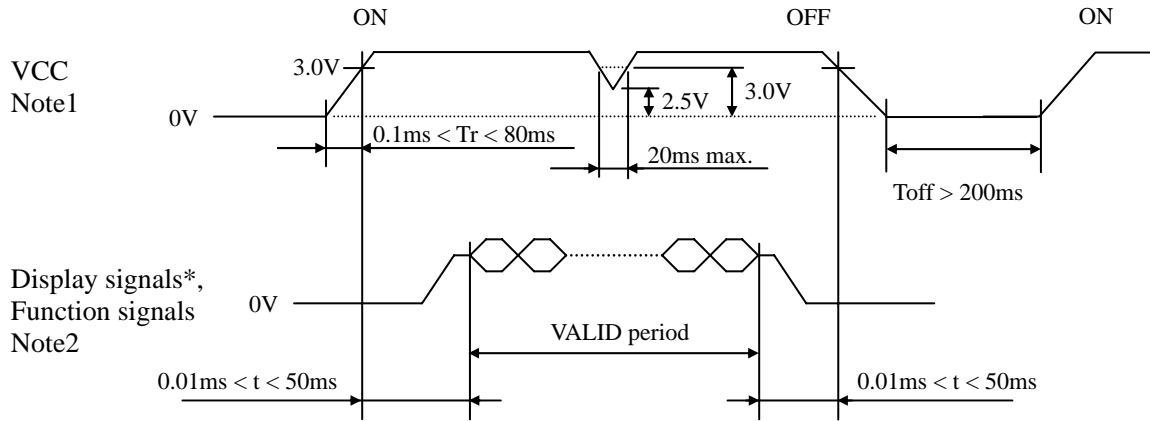
Note1: The permissible ripple voltage includes spike noise.

### 4.3.4 Fuse

Parameter	Fuse		Rating	Fusing current	Remarks
	Type	Supplier			
VCC	FCC16202AB	KAMAYA ELECTRIC Co., Ltd	2.0A	4.0A	Note1
			32V		

Note1: The power supply capacity should be more than the fusing current. If it is less than the fusing current, the fuse may not blow in a short time, and then nasty smell, smoke and so on may occur.

## 4.4 POWER SUPPLY VOLTAGE SEQUENCE



\* These signals should be measured at the terminal of 100Ω resistance.

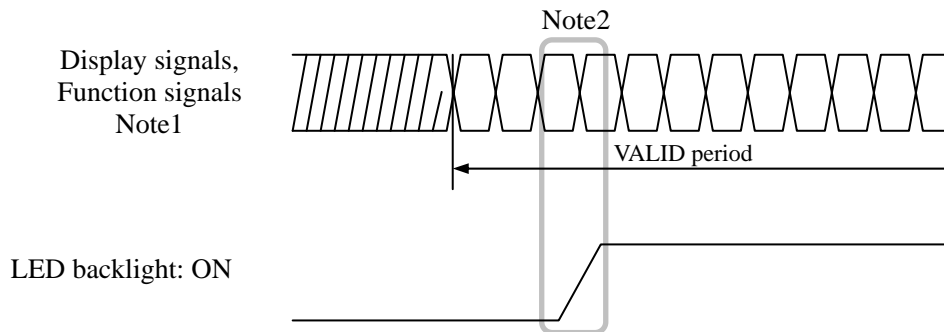
Note1: In terms of voltage variation (voltage drop) while VCC rising edge is below 3.0V, a protection circuit may work, and then this product may not work.

Note2: Display signals (D0+/-, D1+/-, D2+/-, D3+/-, CLK+/-) and function signals (MSL, DPS) must be Low or High impedance, exclude the VALID period (See above sequence diagram), in order to avoid that internal circuit is damaged.

If some of display and function signals of this product are cut while this product is working, even if the signal input to it once again, it might not work normally. VCC should be cut when the display and function signals are stopped.

Note3: The backlight should be turned on within the valid period of display and function signals, in order to avoid unstable data display.

### 4.4.2 Backlight lighting circuit



Note1: These are the display and function signals for LCD panel signal processing board.

Note2: The backlight should be turned on within the valid period of display and function signals, in order to avoid unstable data display.

## 4.5 CONNECTIONS AND FUNCTIONS FOR INTERFACE PINS

### 4.5.1 LCD panel signal processing board

CN1 socket (LCD module side): DF14H-20P-1.25H (Hirose Electric Co., Ltd. (HRS))  
 Adaptable plug: DF14-20S-1.25C (Hirose Electric Co., Ltd. (HRS))

Pin No.	Symbol	Signal	Remarks
1	VCC	Power supply	Note1
2	VCC		
3	GND	Ground	Note1
4	GND		
5	D0-	Pixel data	Note2
6	D0+		
7	GND	Ground	Note1
8	D1-	Pixel data	Note2
9	D1+		
10	GND	Ground	Note1
11	D2-	Pixel data	Note2
12	D2+		
13	GND	Ground	Note1
14	CLK-	Pixel clock	Note2
15	CLK+		
16	GND	Ground	Note1
17	D3-	Pixel data	Note2
18	D3+		
19	DPS	Selection of scan direction	High: Reverse scan Low or Open: Normal scan Note3, Note5
20	MSL	Selection of LVDS input map	High: Input map A Low or Open: Input map B Note4, Note5

Note1: All GND and VCC terminals should be used without any non-connected lines.

Note2: Twist pair wires with 100Ω (Characteristic impedance) should be used between LCD panel signal processing board and LVDS transmitter.

Note3: See "**4.8 SCANNING DIRECTIONS**".

Note4: See "**4.5.4 Connection between receiver and transmitter for LVDS**".

Note5: This terminal is pulled-down in the product. (Pull-down resistance: 50kΩ)

# PRELIMINARY

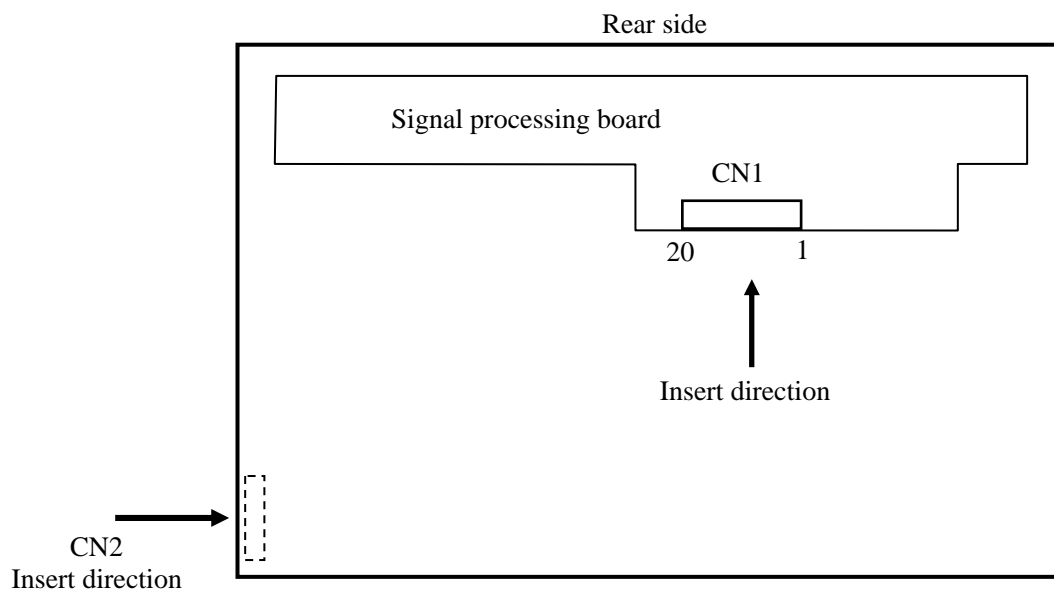
## 4.5.2 Backlight

CN2 plug (LCD module side): SM12B-SRSS-TB (J.S.T. Mgf. Co., Ltd.)

Adaptable socket: SHR-12V-S, SHR-12V-S-B (J.S.T. Mgf. Co., Ltd.)

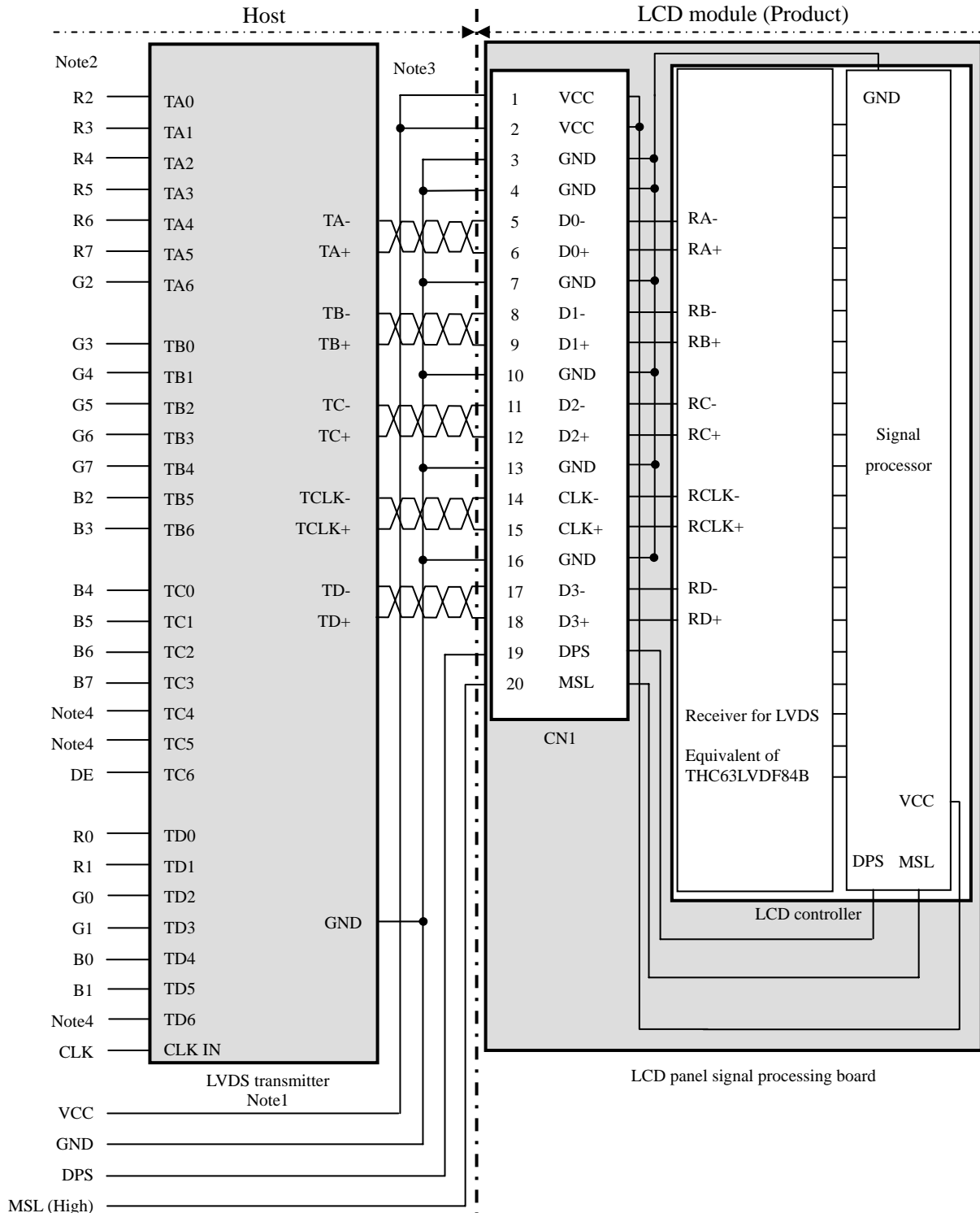
Pin No.	Symbol	Signal	Remarks
1	A1	Anode1	-
2	K1	Cathode1	-
3	A2	Anode2	-
4	K2	Cathode2	-
5	A3	Anode3	-
6	K3	Cathode3	-
7	A4	Anode4	-
8	K4	Cathode4	-
9	A5	Anode5	-
10	K5	Cathode5	-
11	A6	Anode6	-
12	K6	Cathode6	-

## 4.5.3 Positions of plug and socket



### 4.5.4 Connection between receiver and transmitter for LVDS

#### (1) Input LVDS map A (MSL: "High")



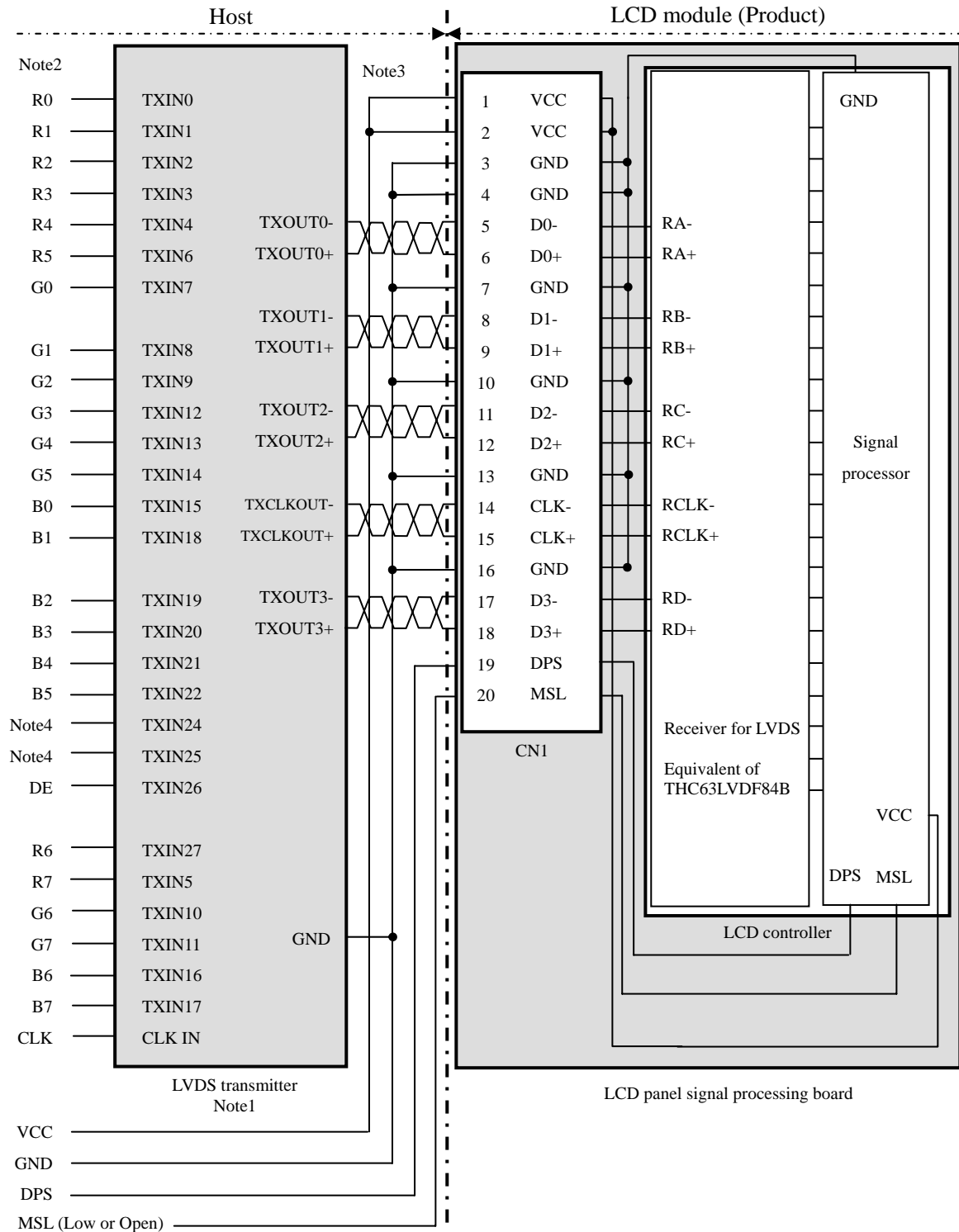
Note1: Recommended transmitter: THC63LVDM83R (THine Electronics Inc.) or equivalent

Note2: LSB (Least Significant Bit) – R0, G0, B0 MSB (Most Significant Bit) – R7, G7, B7

Note3: Twist pair wires with 100Ω (Characteristic impedance) should be used between LCD panel signal processing board and LVDS transmitter.

Note4: Input signals to TC4, TC5 and TD6 are not used inside the product, but do not keep TC4, TC5 and TD6 open to avoid noise problem.

(2) Input LVDS map B (MSL: "Low" or "Open")



- Note1: Recommended transmitter: DS90C383 (National Semiconductor) or equivalent
- Note2: LSB (Least Significant Bit) – R0, G0, B0 MSB (Most Significant Bit) – R7, G7, B7
- Note3: Twist pair wires with 100Ω (Characteristic impedance) should be used between LCD panel signal processing board and LVDS transmitter.
- Note4: Input signals to TXIN24 and TXIN25 are not used inside the product, but do not keep TXIN24 and TXIN25 open to avoid noise problem.



# PRELIMINARY

## 4.6 DISPLAY COLORS AND INPUT DATA SIGNALS

This product can display in equivalent to 16,777,216 colors in 256 gray scales. Also the relation between display colors and input data signals is as the following table.

Display colors		Data signal (0: Low level, 1: High level)																							
		R7	R6	R5	R4	R3	R2	R1	R0	G7	G6	G5	G4	G3	G2	G1	G0	B7	B6	B5	B4	B3	B2	B1	B0
Basic Colors	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
	Red	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Magenta	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
	Green	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	Cyan	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
Red gray scale	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
		0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	dark	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	↑																								
	↓																								
	bright	1	1	1	1	1	1	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Red	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
Red	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
Green gray scale	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
		0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0
	dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0
	↑																								
	↓																								
	bright	0	0	0	0	0	0	0	0	1	1	1	1	1	1	0	1	0	0	0	0	0	0	0	0
Green	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	
Green	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	
Blue gray scale	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
		0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
	dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
	↑																								
	↓																								
	bright	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	0	1
Blue	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0	
Blue	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	

### 4.7 DISPLAY POSITIONS

The following table is the coordinates per pixel (See "4.8 SCANNING DIRECTIONS").

$C(0, 0)$   

R	G	B
---	---	---

$C(0, 0)$	$C(1, 0)$	...	$C(X, 0)$	...	$C(1022, 0)$	$C(1023, 0)$
$C(0, 1)$	$C(1, 1)$	...	$C(X, 1)$	...	$C(1022, 1)$	$C(1023, 1)$
•	•	•	•	•	•	•
•	•	•••	•	•	•	•••
•	•	•	•	•	•	•
$C(0, Y)$	$C(1, Y)$	...	$C(X, Y)$	...	$C(1022, Y)$	$C(1023, Y)$
•	•	•	•	•	•	•
•	•	•••	•	•	•	•
•	•	•	•	•	•	•
$C(0, 766)$	$C(1, 766)$	...	$C(X, 766)$	...	$C(1022, 766)$	$C(1023, 766)$
$C(0, 767)$	$C(1, 767)$	...	$C(X, 767)$	...	$C(1022, 767)$	$C(1023, 767)$

### 4.8 SCANNING DIRECTIONS

The following figures are seen from a front view. Also the arrow shows the direction of scan.

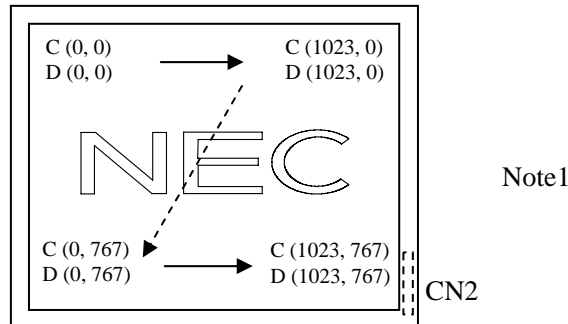


Figure1. Normal scan (DPS: Low or Open)

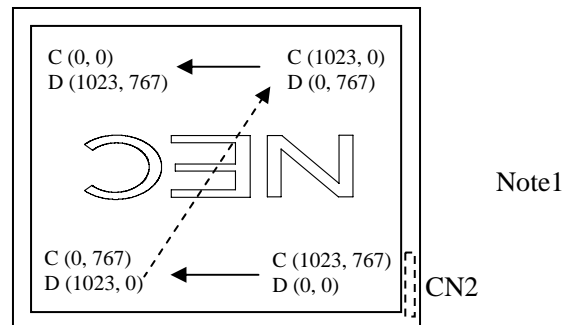


Figure2. Reverse scan (DPS: High)

Note1: Meaning of C (X, Y) and D (X, Y)

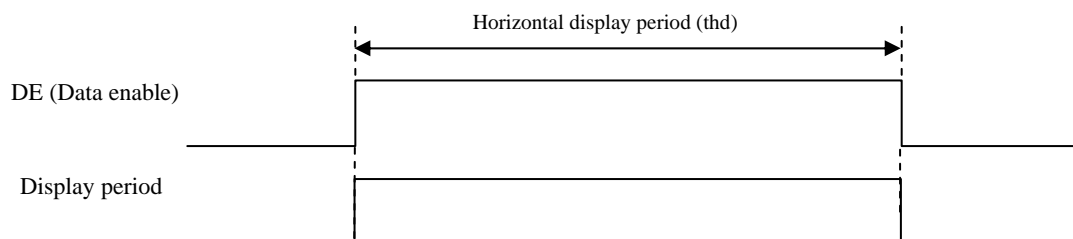
C (X, Y): The coordinates of the display position (See "4.7 DISPLAY POSITIONS".)

D (X, Y): The data number of input signal for LCD panel signal processing board

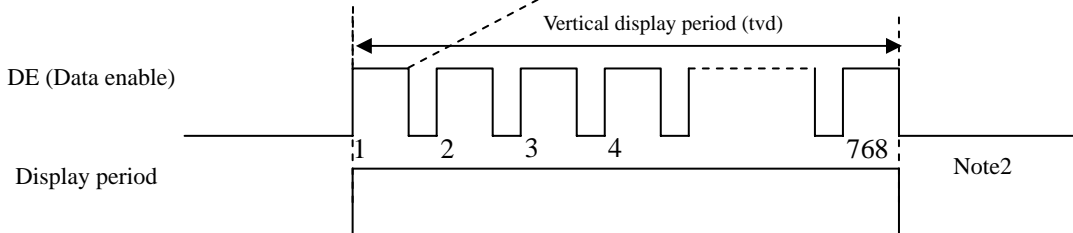
## 4.9 INPUT SIGNAL TIMINGS

### 4.9.1 Outline of input signal timings

- Horizontal signal  
Note1



- Vertical signal  
Note1



Note1: This diagram indicates virtual signal for set up to timing.  
 Note2: See "**4.9.3 Input signal timing chart**" for numeration of pulse.

# PRELIMINARY

## 4.9.2 Timing characteristics

(Note1, Note2, Note3)

Parameter		Symbol	min.	typ.	max.	Unit	Remarks	
CLK	Frequency	1/tc	50.0	65.0	80.0	MHz	15.384ns (typ.)	
	Duty	-	-			-	-	
	Rise time, Fall time	-				ns		
DATA	CLK-DATA	Setup time	-			ns	-	
		Hold time				ns		
	Rise time, Fall time	-				ns		
DE	Horizontal	Cycle	th	15.0	20.676	-	μs	48.363kHz (typ.)
			thd	1,050	1,344	1,800	CLK	
	Vertical (One frame)	Cycle	tv	13.1	16.666	20.0	ms	60.0Hz (typ.)
			tv	770	806	-	H	
		Display period	tvd	768			H	-
	CLK-DE	Setup time	-	-			ns	-
		Hold time	-				ns	
Rise time, Fall time		-				ns		

Note1: Definition of parameters is as follows.

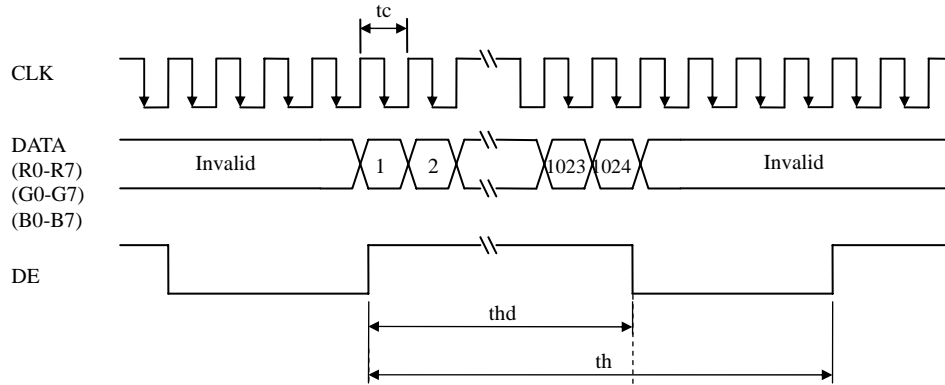
$$tc = 1/CLK, th = 1H, Vf = 1/tv$$

Note2: See the data sheet of LVDS transmitter.

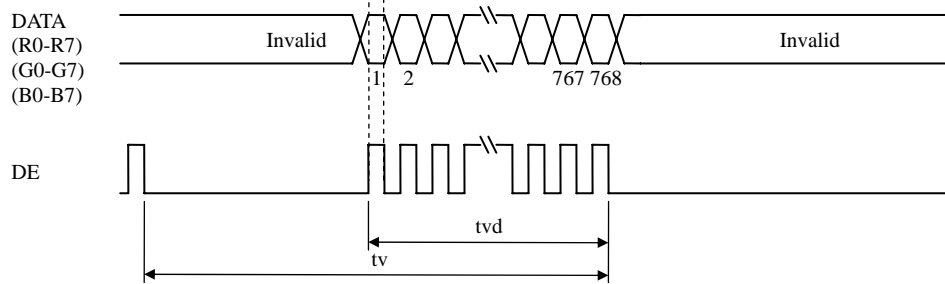
Note3: Vertical cycle (tv) should be specified in integral multiple of Horizontal cycle (th)

### 4.9.3 Input signal timing chart

#### Horizontal timing



#### Vertical timing



4.10 OPTICS

4.10.1 Optical characteristics

(Note1, Note2)

Parameter	Condition	Symbol	min.	typ.	max.	Unit	Measuring instrument	Remarks	
Luminance	White at center $\theta_R = 0^\circ, \theta_L = 0^\circ, \theta_U = 0^\circ, \theta_D = 0^\circ$	L	320	400	-	cd/m <sup>2</sup>	SR-3 or BM-5A	-	
Contrast ratio	White/Black at center $\theta_R = 0^\circ, \theta_L = 0^\circ, \theta_U = 0^\circ, \theta_D = 0^\circ$	CR	350	500	-	-	SR-3 or BM-5A	Note3	
Luminance uniformity	White $\theta_R = 0^\circ, \theta_L = 0^\circ, \theta_U = 0^\circ, \theta_D = 0^\circ$	LU	-	1.2	1.35	-	BM-5A	Note4	
Chromaticity	White	x coordinate	Wx	TBD	TBD	TBD	-	SR-3	Note5
		y coordinate	Wy	TBD	TBD	TBD	-		
	Red	x coordinate	Rx	-	TBD	-	-		
		y coordinate	Ry	-	TBD	-	-		
	Green	x coordinate	Gx	-	TBD	-	-		
		y coordinate	Gy	-	TBD	-	-		
Blue	x coordinate	Bx	-	TBD	-	-			
	y coordinate	By	-	TBD	-	-			
Color gamut	$\theta_R = 0^\circ, \theta_L = 0^\circ, \theta_U = 0^\circ, \theta_D = 0^\circ$ at center, against NTSC color space	C	TBD	50	-	%			
Response time	White to Black	Ton	-	3	5	ms	BM-5A	Note6	
	Black to White	Toff	-	15	21	ms		Note7	
Viewing angle	Right	$\theta_U = 0^\circ, \theta_D = 0^\circ, CR \geq 10$	$\theta_R$	70	80	-	BM-5A or EZ Contrast	Note8	
	Left	$\theta_U = 0^\circ, \theta_D = 0^\circ, CR \geq 10$	$\theta_L$	70	80	-			
	Up	$\theta_R = 0^\circ, \theta_L = 0^\circ, CR \geq 10$	$\theta_U$	70	80	-			
	Down	$\theta_R = 0^\circ, \theta_L = 0^\circ, CR \geq 10$	$\theta_D$	70	80	-			

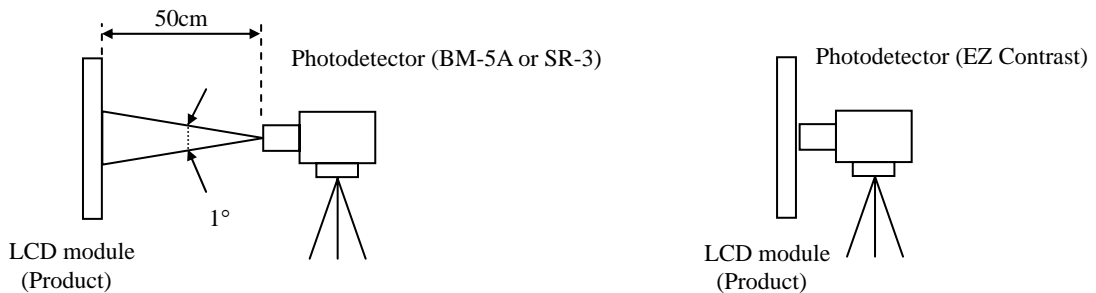
Note1: These are initial characteristics.

Note2: Measurement conditions are as follows.

Ta= 25°C, VCC= 3.3V, IL= 50mA / One circuit, Display mode: XGA,

Horizontal cycle= 1/48.363kHz, Vertical cycle= 1/60.0Hz, DPS= Low or Open: Normal scan

Optical characteristics are measured at luminance saturation after 20minutes from working the product, in the dark room. Also measurement methods are as follows.



Note3: See "4.10.2 Definition of contrast ratio".

Note4: See "4.10.3 Definition of luminance uniformity".

Note5: These coordinates are found on CIE 1931 chromaticity diagram.

Note6: Product surface temperature: TopF= 32°C

Note7: See "4.10.4 Definition of response times".

Note8: See "4.10.5 Definition of viewing angles".

### 4.10.2 Definition of contrast ratio

The contrast ratio is calculated by using the following formula.

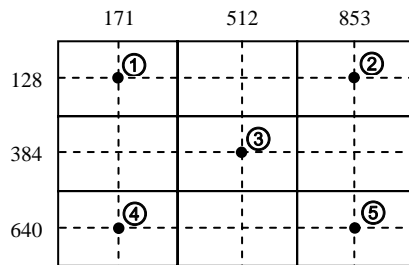
$$\text{Contrast ratio (CR)} = \frac{\text{Luminance of white screen}}{\text{Luminance of black screen}}$$

### 4.10.3 Definition of luminance uniformity

The luminance uniformity is calculated by using following formula.

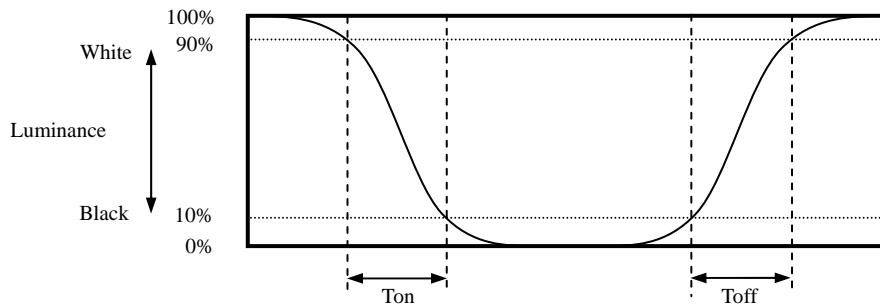
$$\text{Luminance uniformity (LU)} = \frac{\text{Maximum luminance from ① to ⑤}}{\text{Minimum luminance from ① to ⑤}}$$

The luminance is measured at near the 5 points shown below.

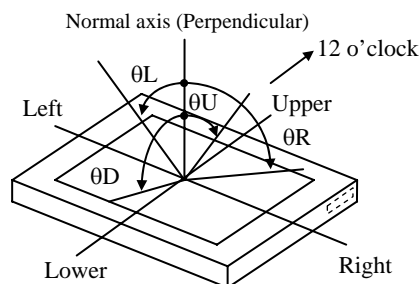


### 4.10.4 Definition of response times

Response time is measured, the luminance changes from "white" to "black", or "black" to "white" on the same screen point, by photo-detector. Ton is the time it takes the luminance change from 90% down to 10%. Also Toff is the time it takes the luminance change from 10% up to 90% (See the following diagram.).



### 4.10.5 Definition of viewing angles



# PRELIMINARY

## 5. ESTIMATED LUMINANCE LIFETIME

The luminance lifetime is the time from initial luminance to half-luminance.

**This lifetime is the estimated value, and is not guarantee value.**

Condition		Estimated luminance lifetime (MTTF) Note1, Note2, Note3	Unit
LED elementary substance	25°C (Ambient temperature of LED) Continuous operation, IL=50mA / One circuit	70,000	h

Note1: MTTF is mean time to half-luminance.

Note2: Estimated luminance lifetime is not the value for LCD module but the value for LED elementary substance.

Note3: By ambient temperature, the lifetime changes particularly. Especially, in case the product works under high temperature environment, the lifetime becomes short.

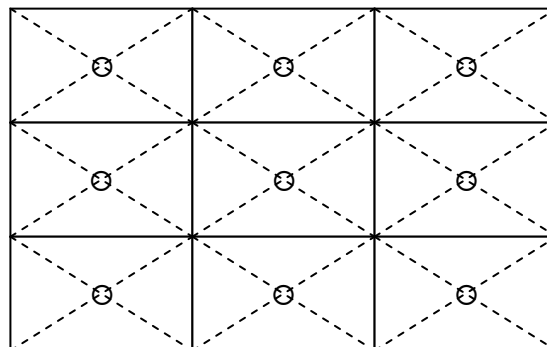


**6. RELIABILITY TESTS**

Test item	Condition	Judgment	Note1
High temperature and humidity (Operation)	① 60 ± 2°C, RH= 90%, 240hours ② Display data is black.	No display malfunctions	
High temperature (Operation)	① 70 ± 3°C, 240hours ② Display data is black.		
Heat cycle (Operation)	① -20 ± 3°C...1hour 70 ± 3°C...1hour ② 50cycles, 4hours/cycle ③ Display data is black.		
Thermal shock (Non operation)	① -20 ± 3°C...30minutes 80 ± 3°C...30minutes ② 100cycles, 1hour/cycle ③ Temperature transition time is within 5 minutes.		
ESD (Operation)	① 150pF, 150Ω, ±10kV ② 9 places on a panel surface Note2 ③ 10 times each places at 1 sec interval		
Dust (Operation)	① Sample dust: No. 15 (by JIS-Z8901) ② 15 seconds stir ③ 8 times repeat at 1 hour interval		
Vibration (Non operation)	① 5 to 100Hz, 11.76m/s <sup>2</sup> ② 1 minute/cycle ③ X, Y, Z directions ④ 50 times each directions	No display malfunctions No physical damages	
Mechanical shock (Non operation)	① 294m/s <sup>2</sup> , 11ms ② X, Y, Z directions ③ 3 times each directions		
Low pressure	Operation	No display malfunctions	
	Non-operation		

Note1: Display and appearance are checked under environmental conditions equivalent to the inspection conditions of defect criteria.

Note2: See the following figure for discharge points.



## 7. PRECAUTIONS

### 7.1 MEANING OF CAUTION SIGNS

The following caution signs have very important meaning. **Be sure to read "7.2 CAUTIONS" and "7.3 ATTENTIONS", after understanding these contents!**



This sign has the meaning that customer will be injured by personnel or the product will sustain a damage, if customer has wrong operations.



This sign has the meaning that customer will be injured by personnel, if customer has wrong operations.

### 7.2 CAUTIONS



**\* Do not shock and press the LCD panel and the backlight! There is a danger of breaking, because they are made of glass. (Shock: To be not greater 294m/s<sup>2</sup> and to be not greater 11ms, Pressure: To be not greater 19.6 N (φ16mm jig))**

### 7.3 ATTENTIONS



#### 7.3.1 Handling of the product

- ① Take hold of both ends without touching the circuit board when the product (LCD module) is picked up from inner packing box to avoid broken down or misadjustment, because of stress to mounting parts on the circuit board.
- ② When the product is put on the table temporarily, display surface must be placed downward.
- ③ When handling the product, take the measures of electrostatic discharge with such as earth band, ionic shower and so on, because the product may be damaged by electrostatic.
- ④ The torque for product mounting screws must never exceed 0.343N·m. Higher torque might result in distortion of the bezel. And the length of product mounting screws must be ≤ 2.8mm.
- ⑤ The product must be installed using mounting holes without undue stress such as bends or twist (See outline drawings). And do not add undue stress to any portion (such as bezel flat area). Bends or twist described above and undue stress to any portion may cause display mura.
- ⑥ Do not press or rub on the sensitive product surface. When cleaning the panel surface, wipe it with a soft dry cloth.
- ⑦ Do not push nor pull the interface connectors while the product is working.
- ⑧ When handling the product, use of an original protection sheet on the product surface (polarizer) is recommended for protection of product surface. Adhesive type protection sheet may change color or characteristics of the polarizer.
- ⑨ Usually liquid crystals don't leak through the breakage of glasses because of the surface tension of thin layer and the construction of LCD panel. But, if you contact with liquid crystal for the worst, please wash it out with soap.

## 7.3.2 Environment

- ① Do not operate or store in high temperature, high humidity, dewdrop atmosphere or corrosive gases. Keep the product in packing box with antistatic pouch in room temperature to avoid dusts and sunlight, when storing the product.
- ② In order to prevent dew condensation occurring by temperature difference, the product packing box should be opened after enough time being left under the environment of an unpacking room. Evaluate the leaving time sufficiently because a situation of dew condensation occurring is changed by the environmental temperature and humidity. (Recommended leaving time: 6 hours or more with packing state)
- ③ Do not operate in high magnetic field. Circuit boards may be broken down by it.
- ④ This product is not designed as radiation hardened.

## 7.3.3 Characteristics

**The following items are neither defects nor failures.**

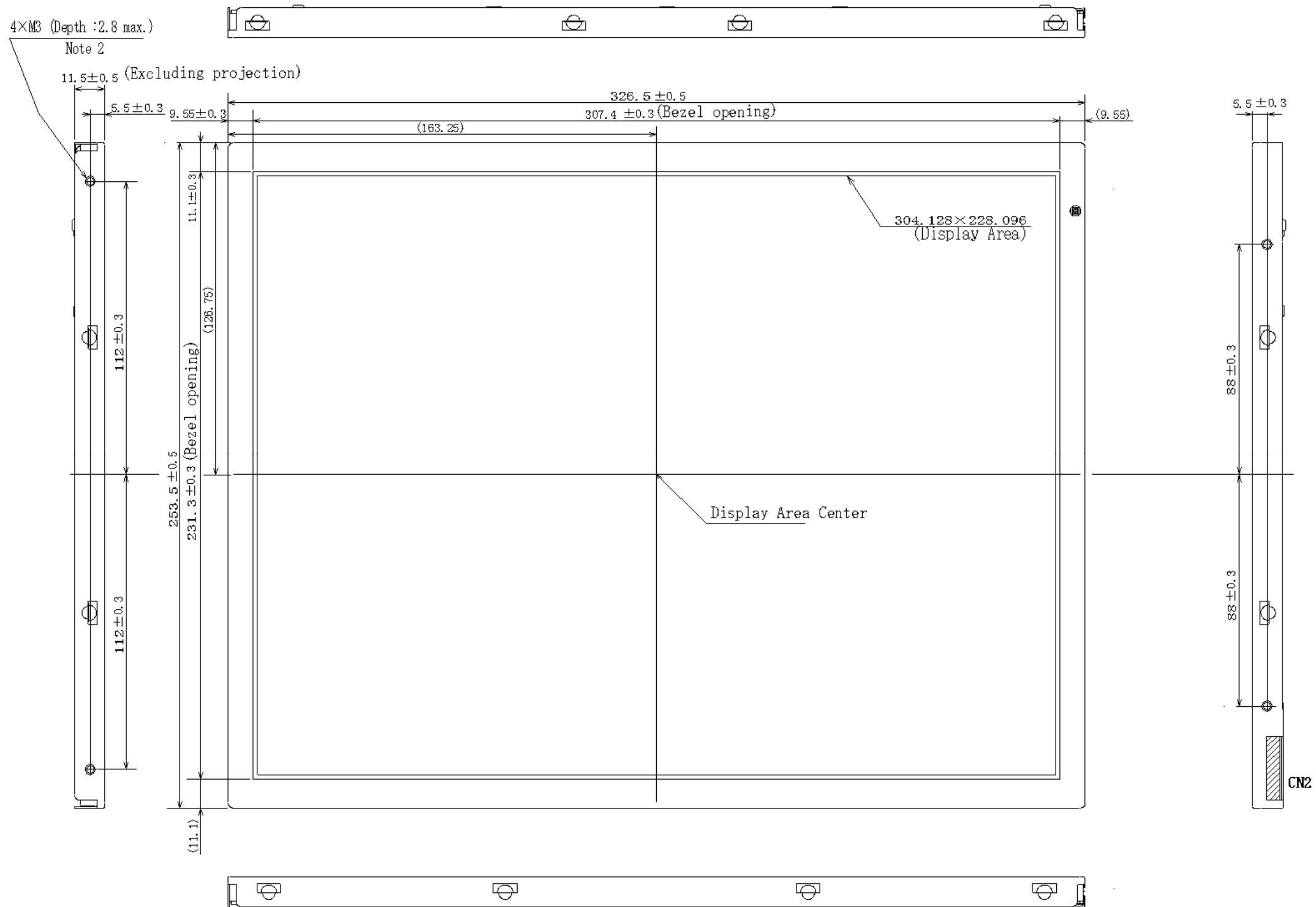
- ① Characteristics of the LCD (such as response time, luminance, color uniformity and so on) may be changed depending on ambient temperature. If the product is stored under condition of low temperature for a long time, it may cause display mura. In this case, the product should be operated after enough time being left under condition of operating temperature.
- ② Display mura, flicker, vertical seam or small spot may be observed depending on display patterns.
- ③ Do not display the fixed pattern for a long time because it may cause image sticking. Use a screen saver, if the fixed pattern is displayed on the screen.
- ④ The display color may be changed depending on viewing angle because of the use of condenser sheet in the backlight.
- ⑤ Optical characteristics may be changed depending on input signal timings.

## 7.3.4 Other

- ① All GND and VCC terminals should be used without any non-connected lines.
- ② Do not disassemble a product or adjust variable resistors.
- ③ See "REPLACEMENT MANUAL FOR LAMP HOLDER SET", when replacing LED holder.
- ④ Pack the product with original shipping package, in order to avoid any damages during transportation, when returning the product to NEC for repair and so on.

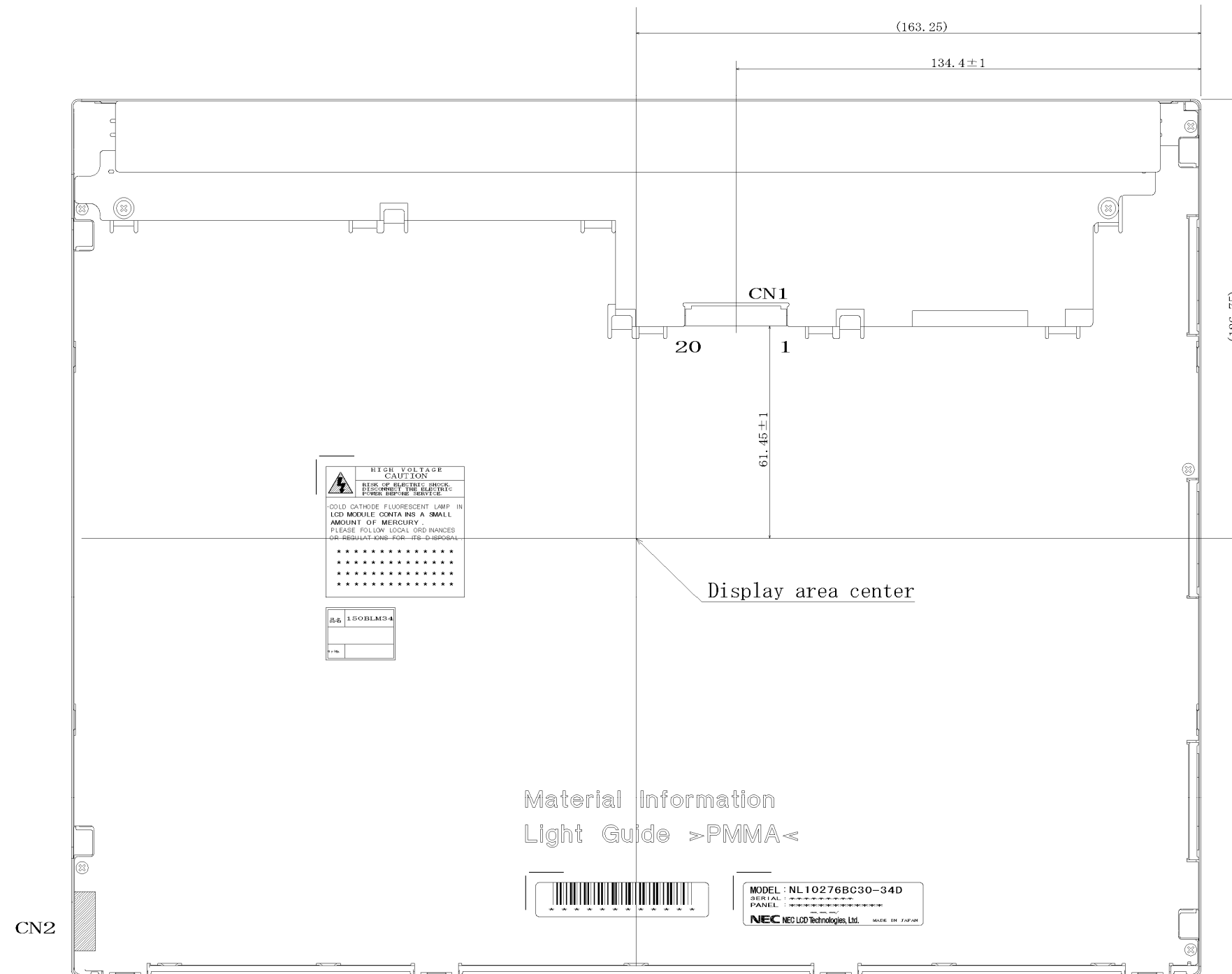
8. OUTLINE DRAWINGS

8.1 FRONT VIEW



Unit: mm

8.2 REAR VIEW


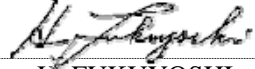


Unit: mm

# PRELIMINARY

## REVISION HISTORY

*The inside of latest specifications is revised to the clerical error and the major improvement of previous edition. Only a changed part such as functions, characteristic value and so on that may affect a design of customers, are described especially below.*

Edition	Document number	Prepared date	Revision contents and signature
1st edition	DOD-PP-0753	Mar. 18, 2009	<p><b>Revision contents</b></p> <p>New issue</p> <p><b>Signature of writer</b></p> <div style="display: flex; justify-content: space-between;"> <div style="text-align: center;"> <p><i>Approved by</i></p>             _____  <b>H. FUKUYOSHI</b> </div> <div style="text-align: center;"> <p><i>Checked by</i></p>           _____            _____         </div> <div style="text-align: center;"> <p><i>Prepared by</i></p>             _____  <b>H. FUKUYOSHI</b> </div> </div>